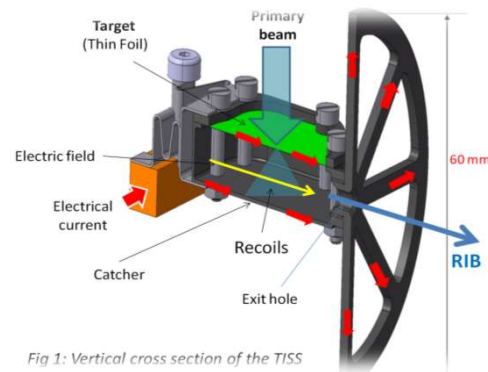


Ni target development for TULIP project

Pascal Jardin¹, **Vincent Bosquet**¹, **Samuel Damoy**¹, **Georges Frémont**¹,
and **Marion MacCormick**²

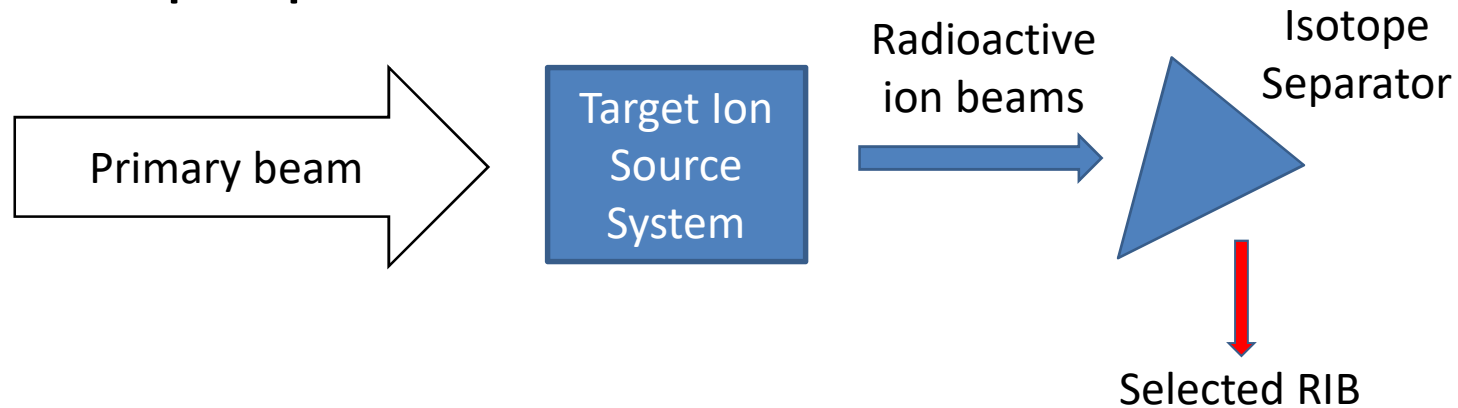
¹GANIL, Grand Accélérateur National d'Ions Lourds, Bvd H. Becquerel, BP55027 14076 Caen cedex5, France

²IJCLab, Institut Joliot Curie Laboratory, 15 Rue Georges Clemenceau, 91400 Orsay, France



Production of radioactive ion beams at GANIL/SPIRAL1

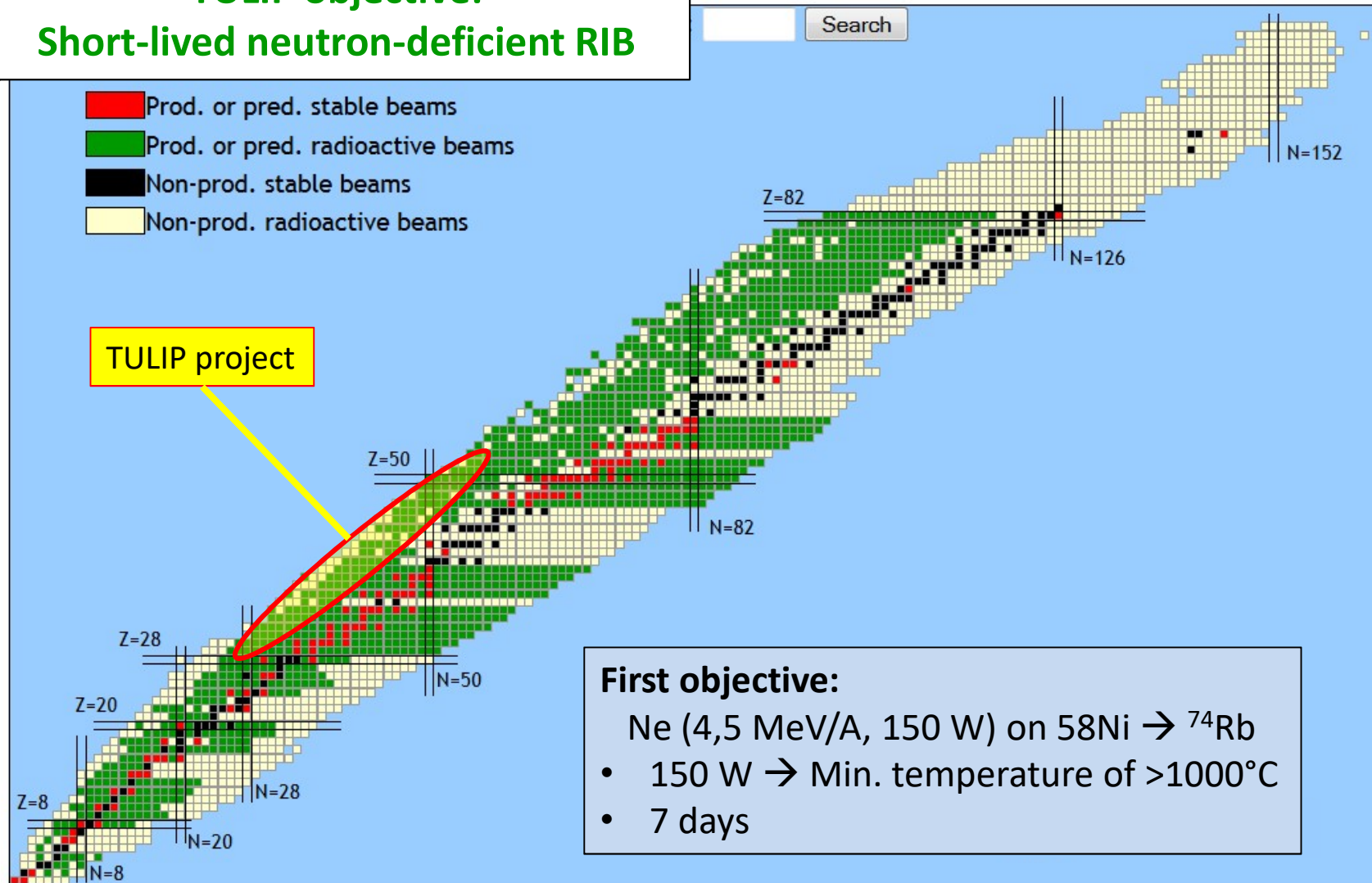
Method: Isotope Separator On Line



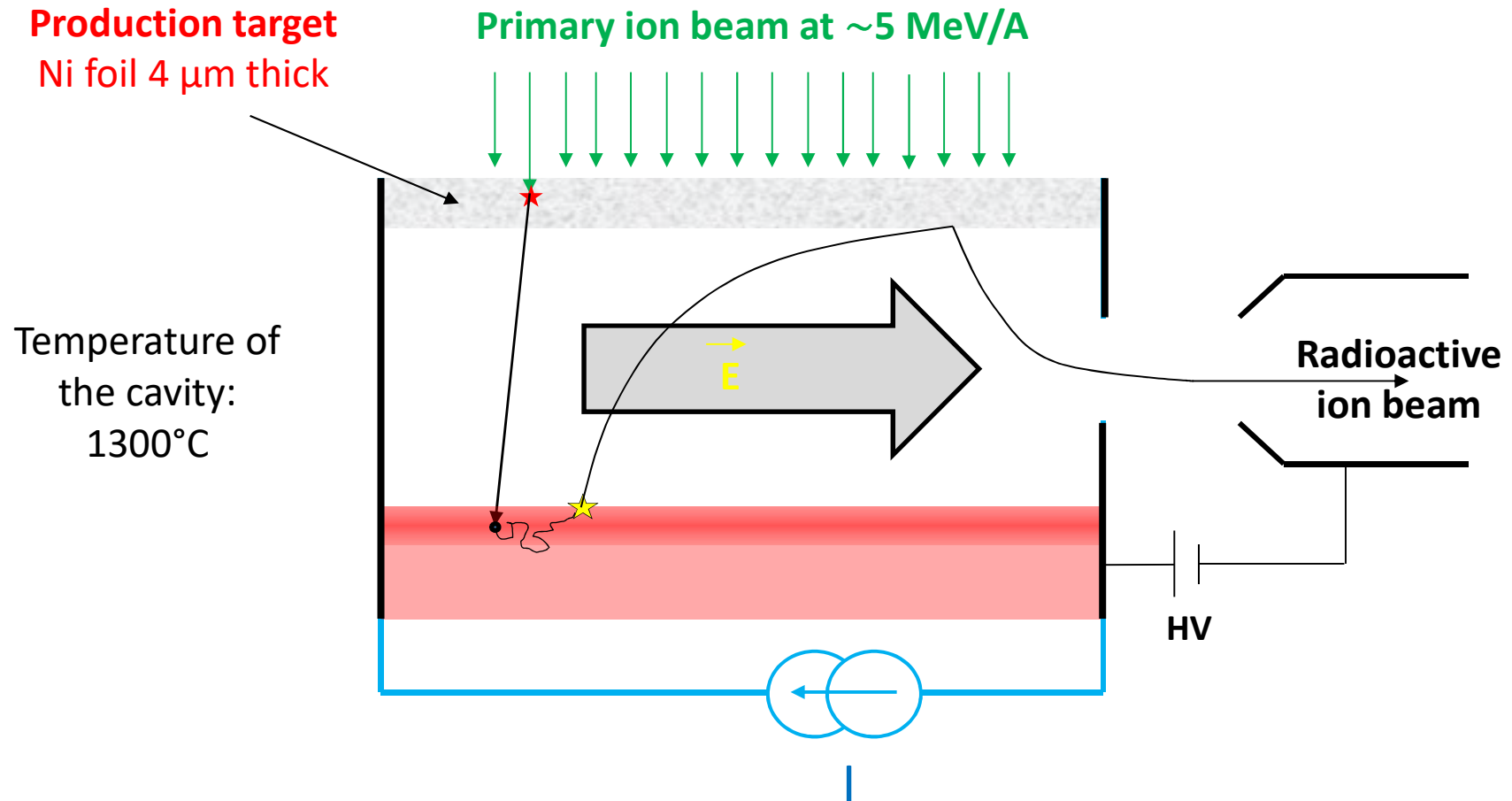
Primary beams: from C to U, Energy up to 95 MeV/A

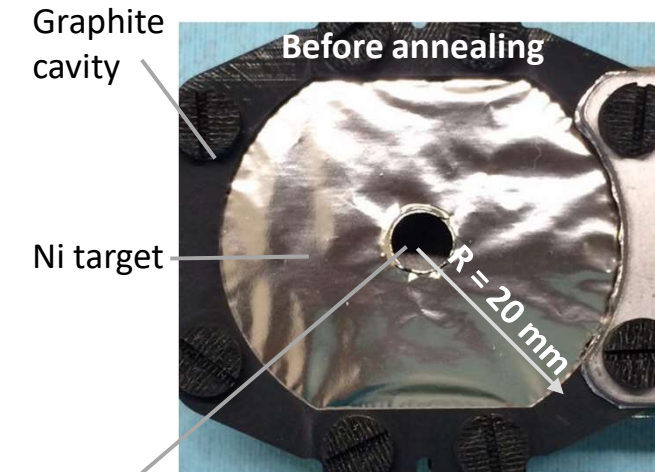
- Thick target, from C to Nb
- « Thin » targets: submitted to safety autorisation for $M > Nb$

**TULIP objective:
Short-lived neutron-deficient RIB**



Principle

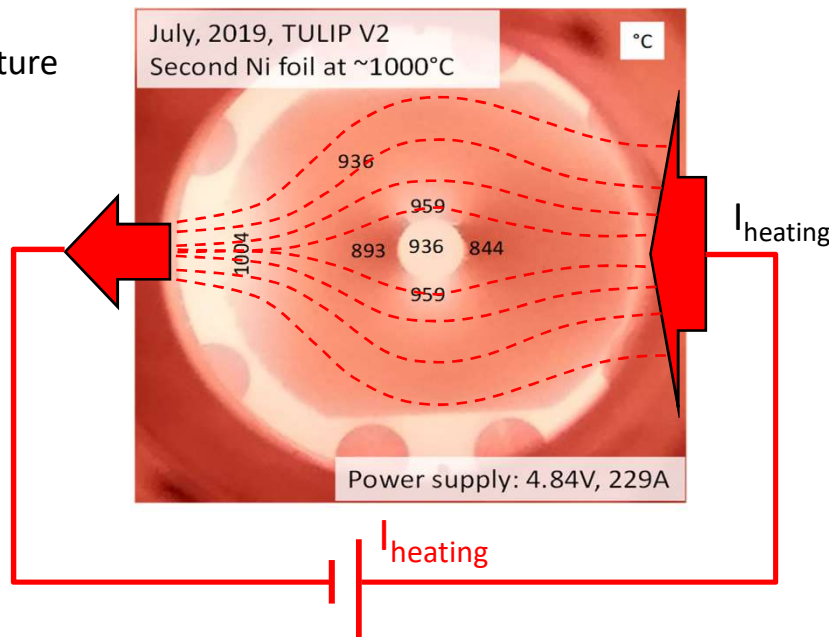




Thermal tests with TULIP V2: 4 μm thick pure Ni target

Annealing: 3 hours at up to 1350°C

6 mm hole for catcher temperature measurement



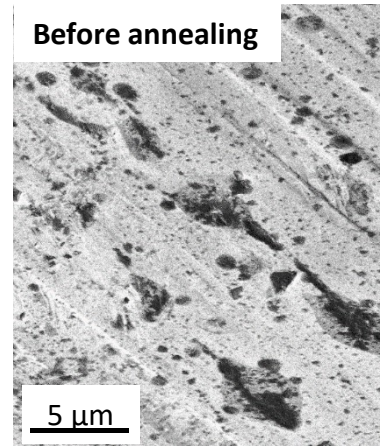
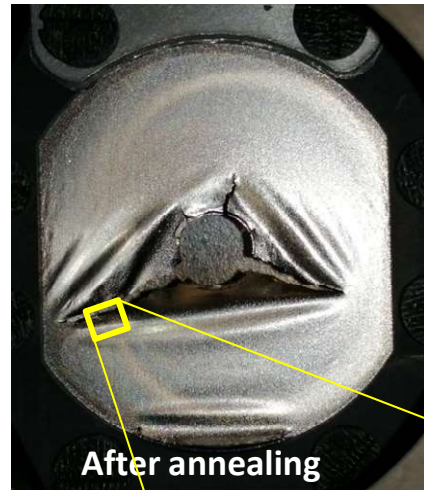
Shrinking and tearing of the foil

Why?

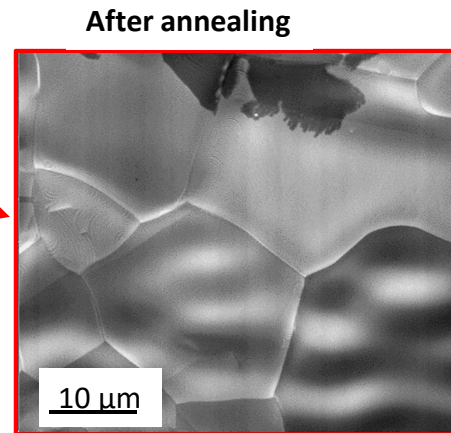
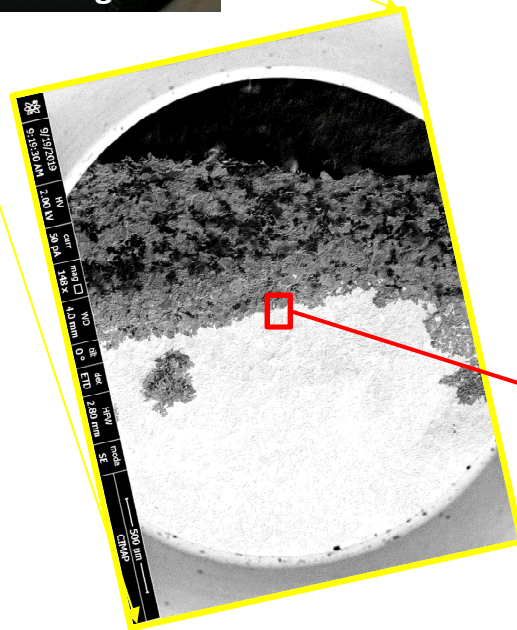
Ni foil supplier: Goodfellow, réf LS 482946

INTDS, PSI 25-30 September 2022

5



Traces of rolling



SEM (Scanning Electron Microscope) analysis of the foil damage

~ 3h at $T \sim 1350^{\circ}\text{C}$

Crystallisation

Crystallization, shrinking,
fusion, tearing

Thermal tests

Behaviour of the target foil at high temperature (1350°C max.): 3 targets tested

- One with TULIP V1: temperature difference of 450°C* at the surface of the target.
Lifetime : ~3 hours at ~**1310°C**
- Two with TULIP V2: temperature difference of 153°C* . Lifetime : ~3 hours at **1350°C**
and ~8 hours at ~ **1300°C** at maximum

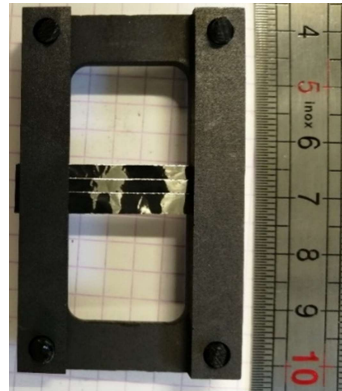
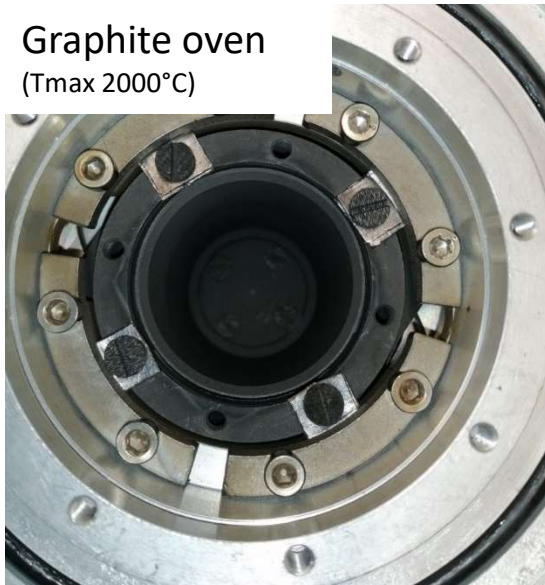


- Temperature difference reduced to 109°C* on TULIP V3 and target mounted with more slack → beginning of shrinking after 2,5h x **1040°C**

* According to ANSYS simulations

Systematic annealing of pure Ni (4 μm) foil in a graphite oven

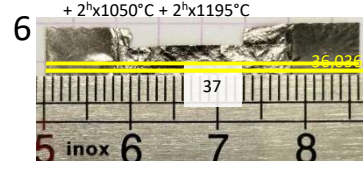
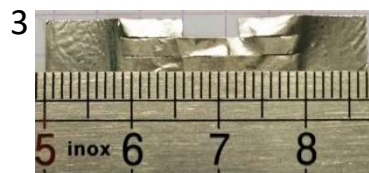
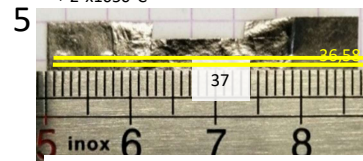
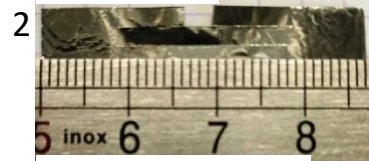
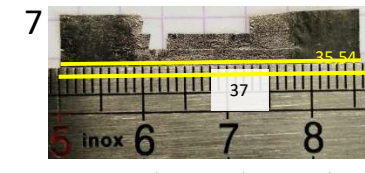
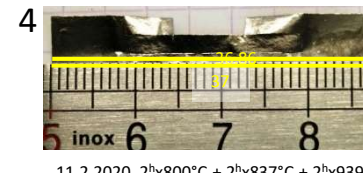
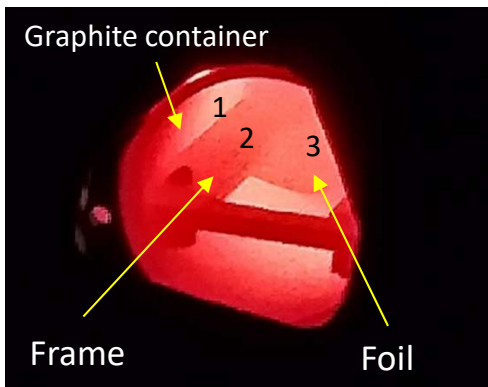
Graphite oven
(Tmax 2000°C)



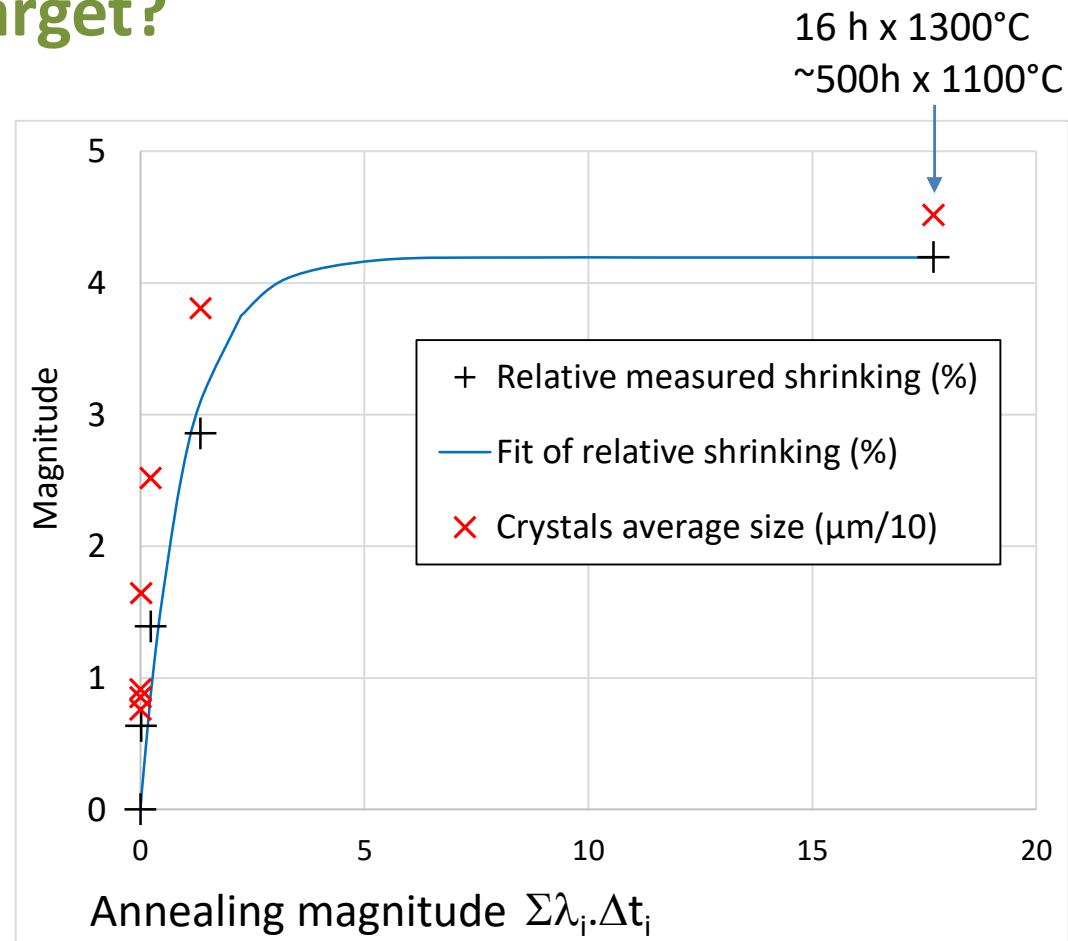
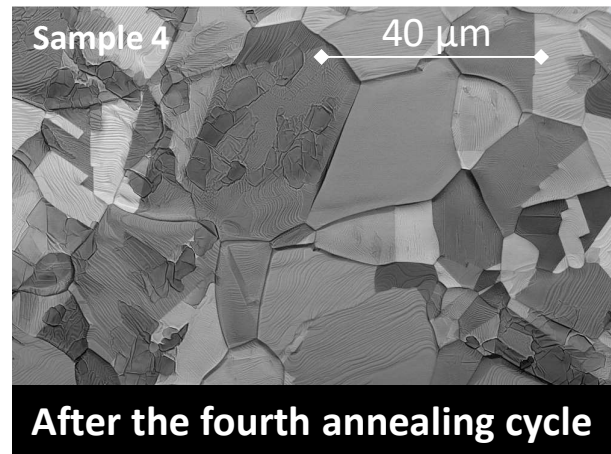
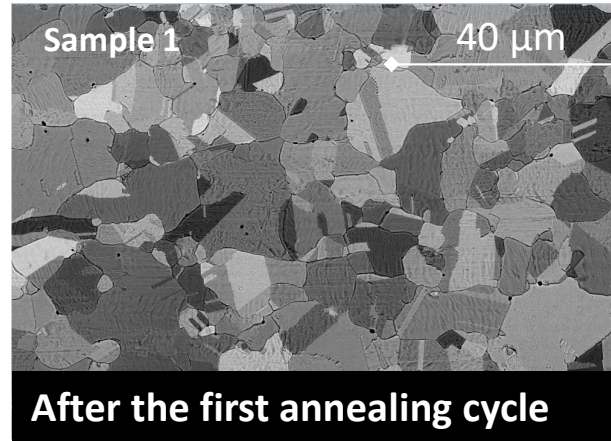
Samples for microscopic analysis



Frame and sample in the oven



What changes in the target?

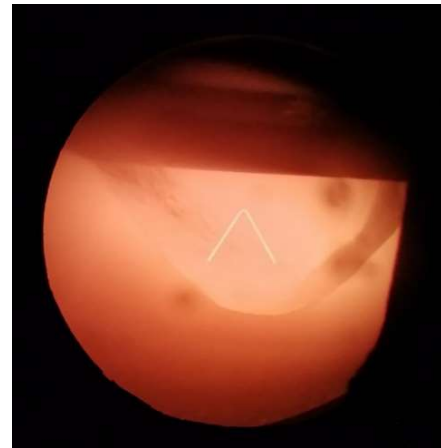


➔ Possible saturation

- takes into account:
- the mobility of atoms,
 - the temperature,
 - the annealing time.

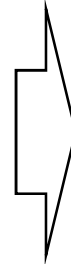
New test to verify the saturation existence

After 31h07 at 1110°C



Result

- Can be handled after annealing but more fragile
- Evaporation rate of 4,7%
- Relative shrinking higher than 10%: **no saturation!**



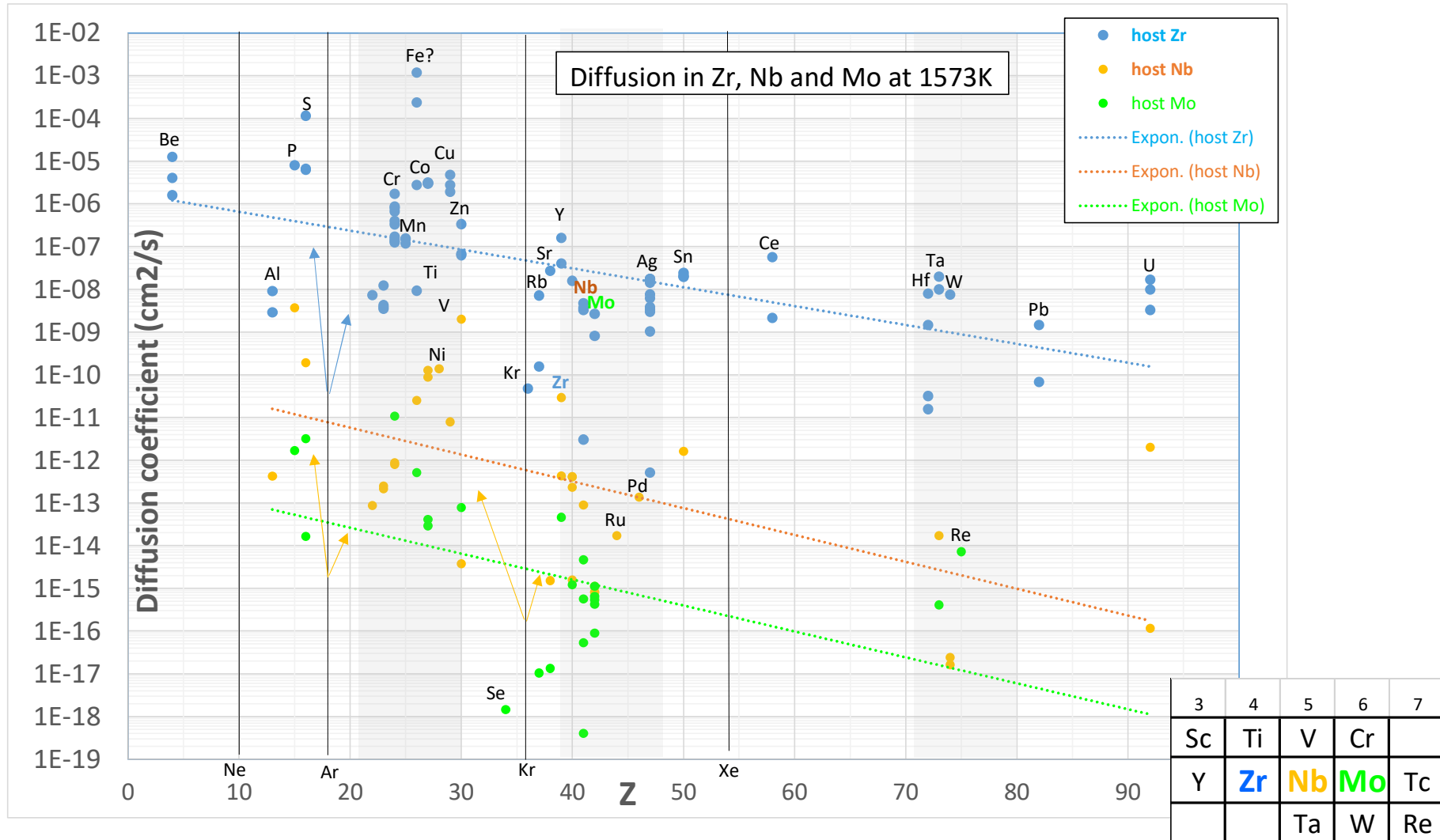
Pure Ni target used at 1300°C, and even at 1110°C must be abandoned

**How to stabilize the target material?
or
How to limit the mobility of the atoms?**

By adding another element?

Which one?

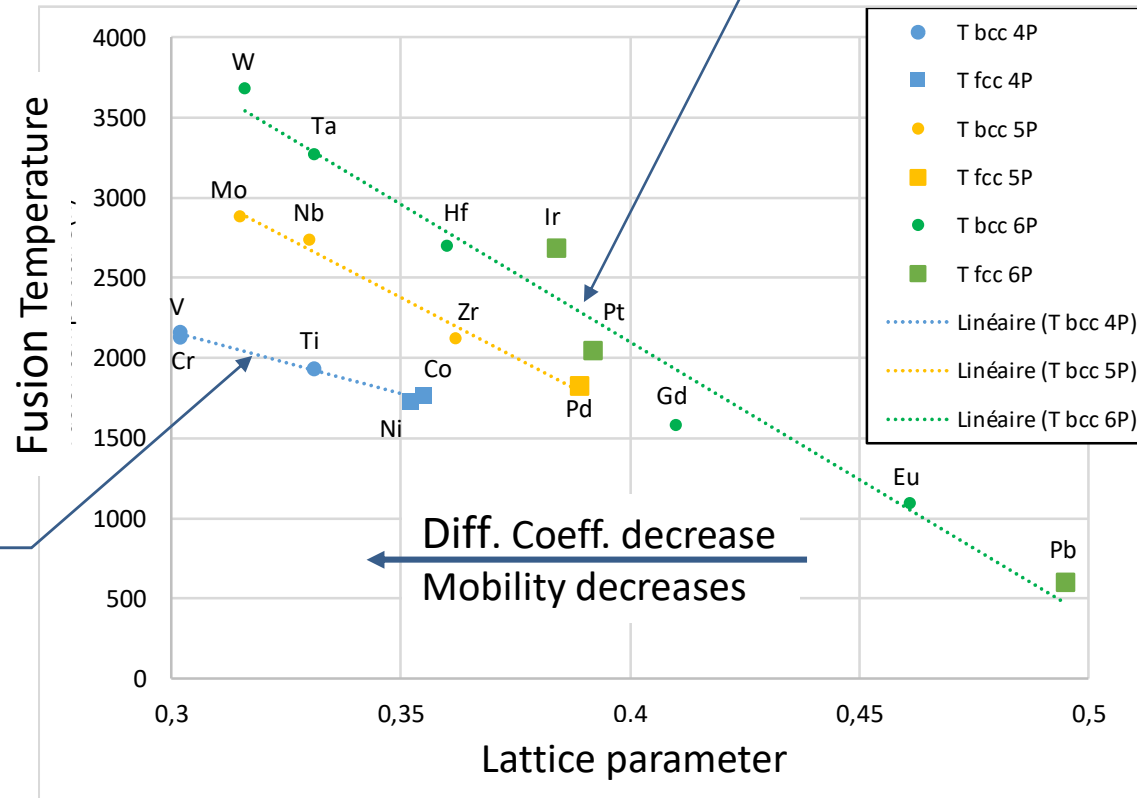
Mobility of atoms in a material <-> Diff. Coefficient



HANDBOOK OF SELF-DIFFUSION AND IMPURITY DIFFUSION IN PURE METALS » DE G. NEUMANN ET DE G.J. BEYER ET AL., NIM B 204 (2003) 225-234

Lattice parameter and mobility

Elements of the sixth period:
Out of SPIRAL1 safety authorization



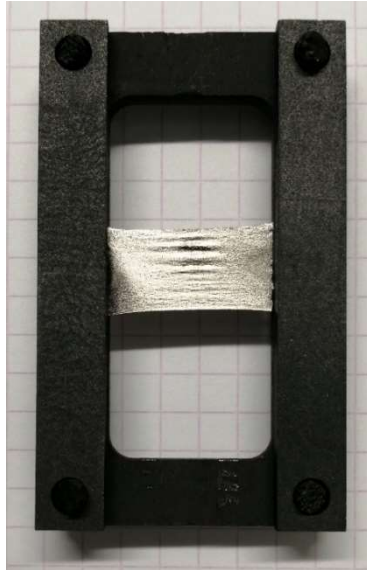
Elements of the fourth period:
Too close to Ni

➔ Mo could be an adequate material.

(Binary phase diagrams of 40 potential Ni-X alloys have also been considered)

First test with a sample of Mo (0,09 μm) - Ni (4 μm) - Mo (0,09 μm)

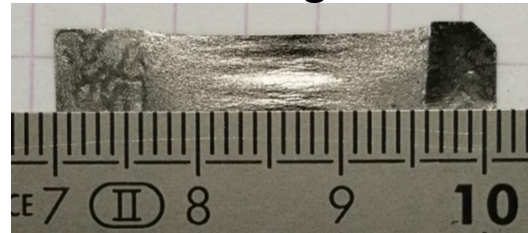
Mo deposited on Ni by evaporation



Before annealing



After annealing



29.5 h at 1250°C

Relative shrinking lower than 1% (10% for pure Ni at 1110°C x 31h)

Relative mass evaporation of 0.8% (> 4,2% for pure Ni at 1290°C x 15h)

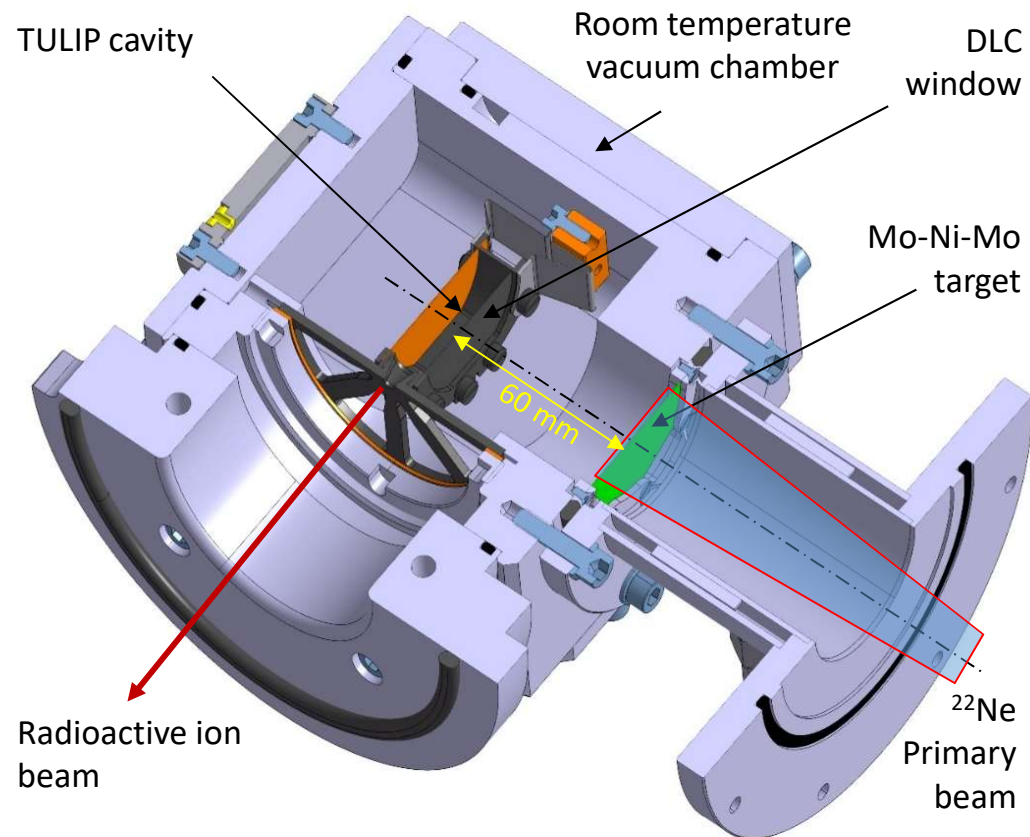
➔ Encouraging result, but will it be sufficient for 7 days?

➔ Next test with 0,3 μm of Mo on each face, and at lower temperature

How to reduce the target temperature?

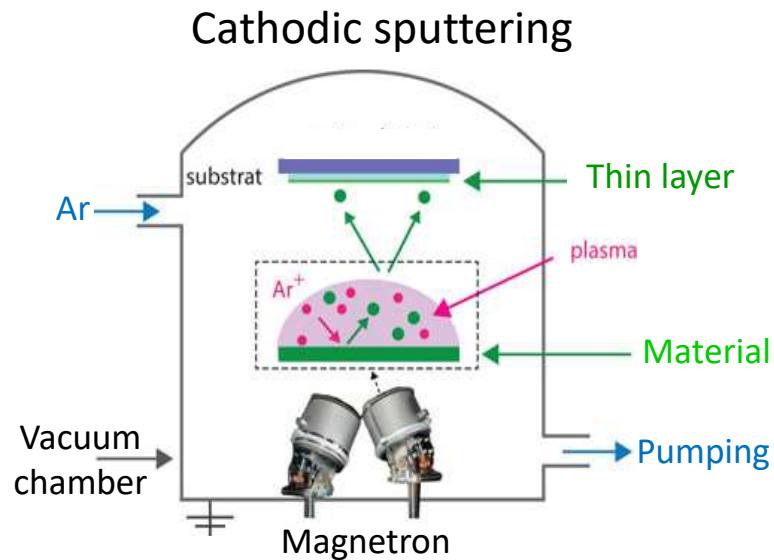
By placing the target 60 mm upstream from the cavity,

- $T_{\text{target}} = 370^{\circ}\text{C}$ without beam
- $T_{\text{target}} \sim 1100^{\circ}\text{C}$ with 30W of beam deposited in the target

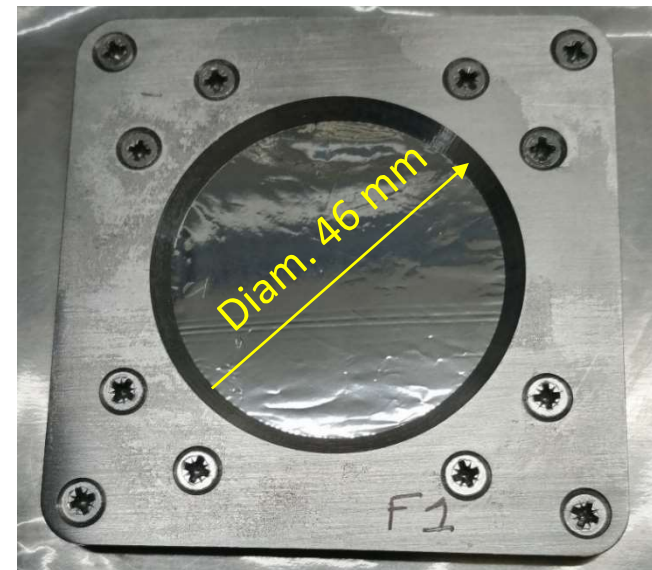


Realization of a Mo (0,3 μm) - Ni (4 μm) -Mo (0,3 μm) sandwich target

Mo deposited on Ni by cathodic sputtering



*Done by Kerdry company
<https://kerdry.com>*

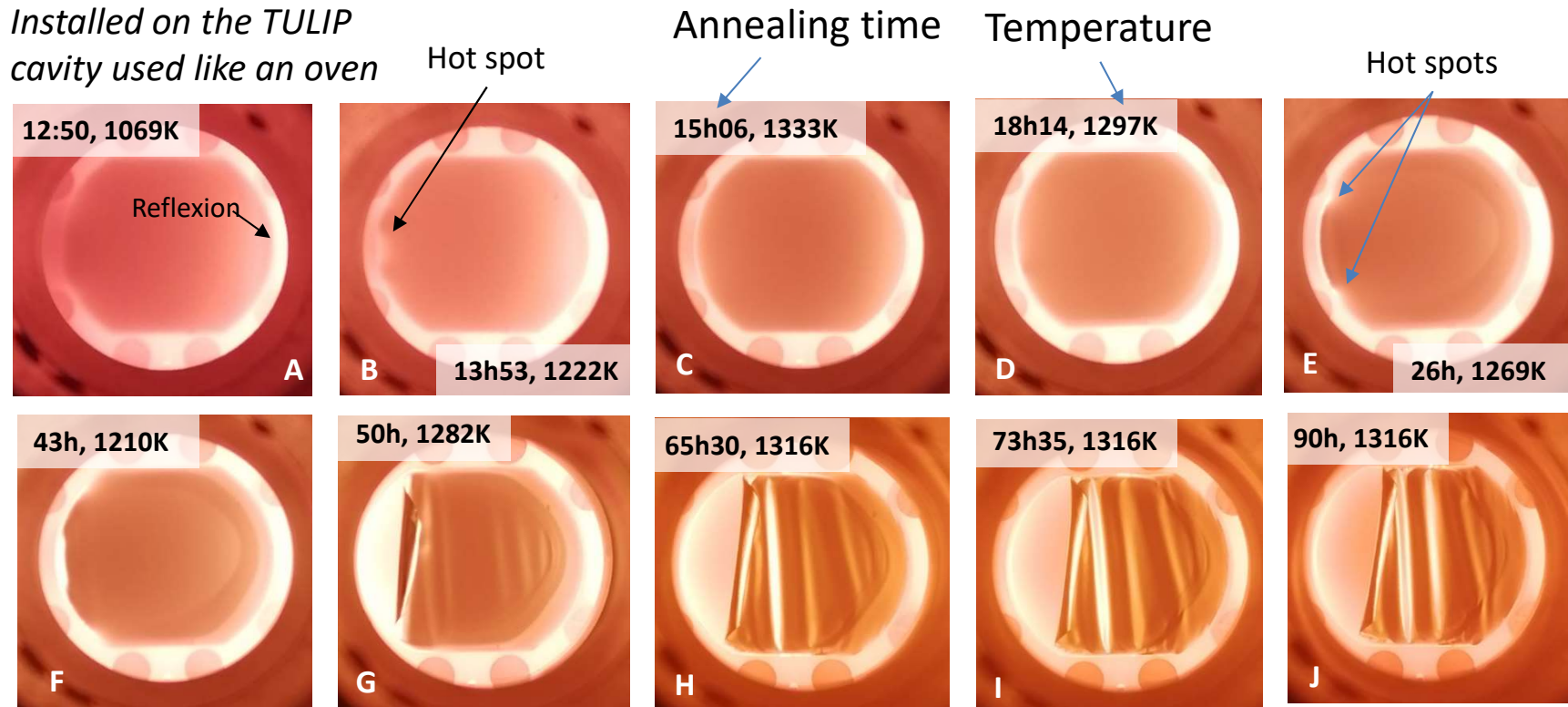


Mo thickness measured on each face after deposition: 0,3 μm +/- 2%

Thermal test of Mo

(0,3 μm) – Ni (4,2 μm) – Mo (0,3 μm) target

Installed on the TULIP cavity used like an oven



After 98 hours of annealing at an average temperature of $\sim 1000^\circ\text{C}$

- Foil still flexible, easy to handle
- Relative shrinking close to 0% (>10% for pure Ni after 31h07 at 1110°C)
- Relative mass evaporation of 10% (> 4,7% for pure Ni after 31h07 at 1110°C)

➔ **Acceptable for the first on-line test**

On line test: ^{22}Ne Beam @ 4,5 MeV/A

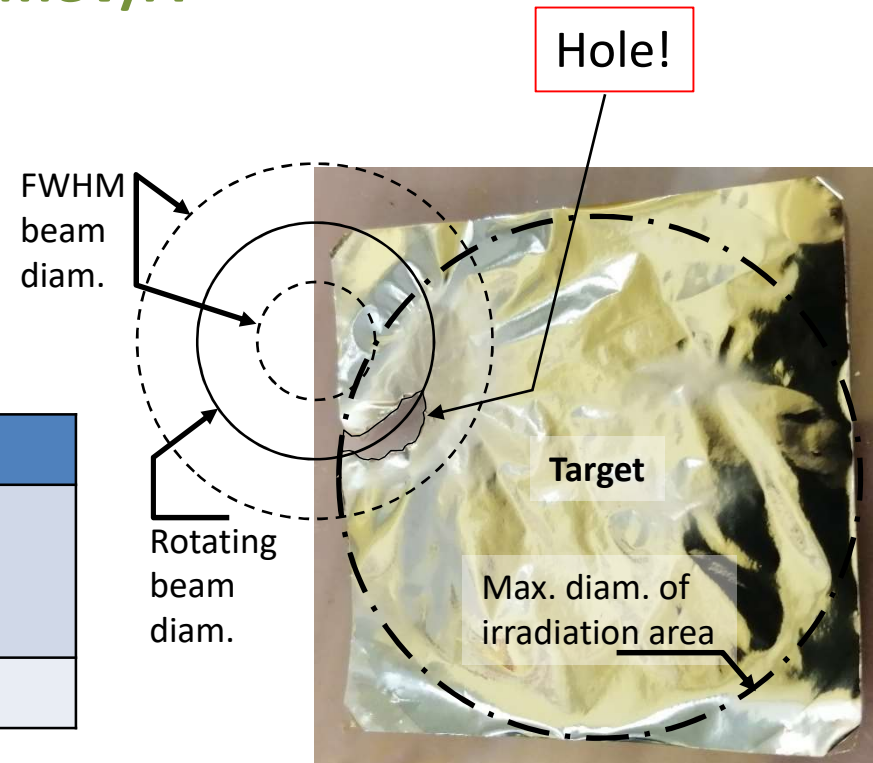
Fluency: $1,7 \times 10^{16}$ part/cm² in 9 hours

Power : up to 111 W

Ni emissivity : 0,19

Mo emissivity : 0,35

	Temperature (°C)	
Max. Target Power density (W/cm ²)	$\epsilon=0.19$	$\epsilon=0.35$
8	1120	920



Excessive focussing or power density of the beam
(sputtering excluded)

⇒ Beam characteristics must be better controlled

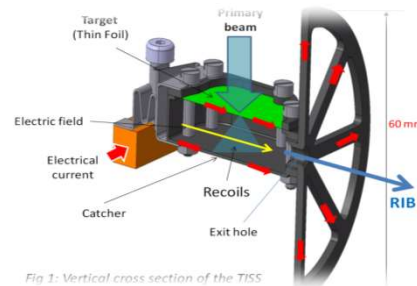
Preliminary conclusion

Mo(0,3 μ m)-Ni (4 μ m)-Mo (0,3 μ m) sandwich

- seems to satisfy the stability requirement of the target if used at 1100°C
- allows to work for few hours (and to produce neutron deficient Rb⁺ ions)
- Beam power density must be better controlled (or/and reduced) to test its life-time
- Next on-line test is expected by Spring 2023

Thank you for your attention

Pascal Jardin¹, Vincent Bosquet¹, Samuel Damoy¹, Georges Frémont¹, and Marion MacCormick²



Which material could be associated to Ni?

Binary phase diagrams studied of Ni + X

	1																	18
1																		
2		2											13	14	15	16	17	
3																		
4		Ca	3	4	5	6	7	8	9	10	11	12						
5			Y	Zr		Mo		Ru	Rh	Pd	Ag	Cd			Sn	Sb	Te	
6					Ta	W	Re	Os		Pt	Au				Pb	Bi		
7																		
			Ce, Dy, Er, Gd, Pr, Pu, Sm, U, Yb															

Pink: need a specific safety study

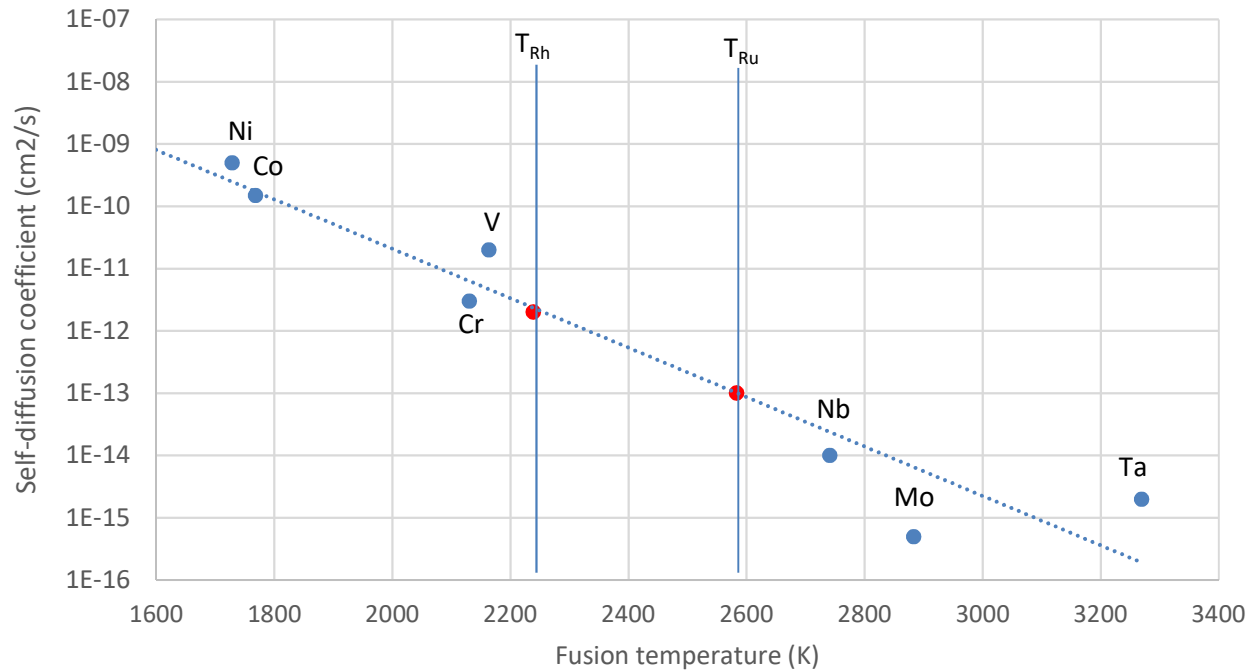
Orange: complex phase diagram or too low fusion temperature (<1570K)

Green : phase diagram ok and alloy fusion temperature > 1573K

Cr, Co and Cu are too close to Ni

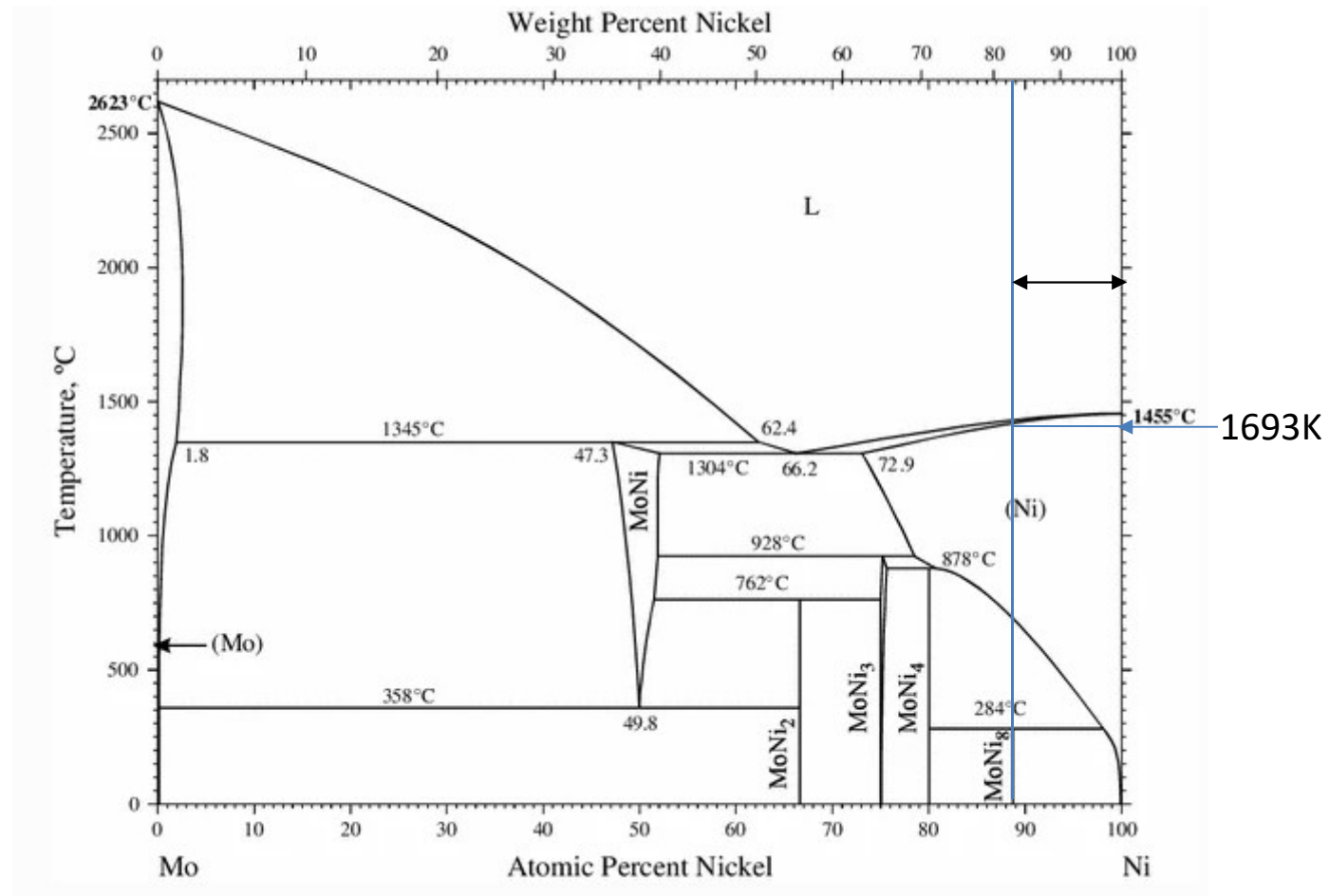
→ Mo, Ru and Rh could be good candidates

Mobility or self-diffusion versus fusion temperature



	1																	18
1		2											13	14	15	16	17	
2		Be											B	C		O		
3			3	4	5	6	7	8	9	10	11	12	Al	Si	P	S		
4		Ca	Sc	Ti	V	Cr		Fe	Co	Ni	Cu	Zn	Ga	Ge	As	Se		
5			Y	Zr	Nb	Mo	Tc	Ru	Rh	Pd	Ag	Cd		Sn	Sb	Te		
6					Ta	W	Re	Os		Pt	Au			Pb	Bi			
7																		

Ni-Mo phase diagram



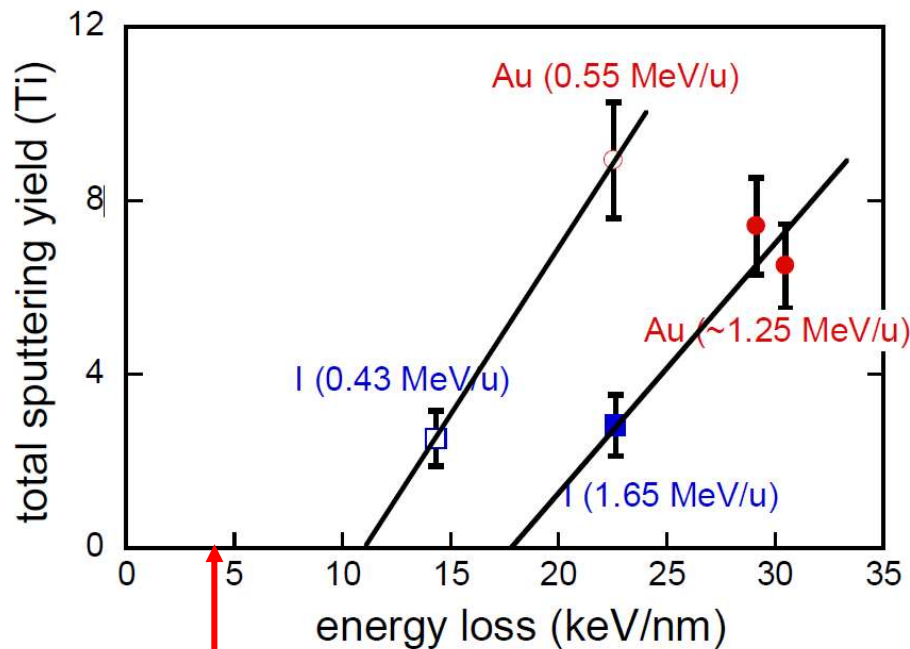
Okamoto, H. *Supplemental Literature Review of Binary Phase Diagrams. Phase Equilib. Diffus.* **35**, 208–219 (2014).

What about sputtering?

M. Toulemonde, C. Dufour, CIMAP, Caen (France)

Toulemonde et al. Phys. Rev. B46(1992)14362
Dufour et al. J. Phys.: Condens. Matt. 5(1993)4573
Toulemonde et al. Nucl. Instr. Meth. B66-167(2000)903

Titanium sputtering



^{22}Ne @ 4,5 MeV/A in Ni

Sputtering rate required to explain the hole: ~ 2000 at / ion
Sputtering damage negligible for an energy loss of 4 keV/nm.
Can not explain the hole
Confirmed by A. Benyagoub (CIMAP)